

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
100V	6.0Ω @ V_{GS} = 10V	170mA

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Small Servo Motor Control
- Power MOSFET Gate Drivers

Switching Applications

Features

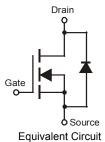
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- High Drain-Source Voltage Rating
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

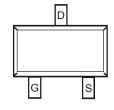
Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.006 grams (approximate)









Top View

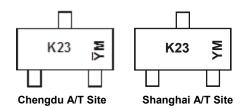
Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
BSS123W-7-F	Standard	SOT323	3000/Tape & Reel
BSS123WQ-7-F	Automotive	SOT323	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html
- 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.

Marking Information



K23 = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)

 $\overline{Y}M$ = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or \overline{Y} = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date Code Key

Date Code	rvey															
Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	N	Р	R	S	Т	U	V	W	Х	Υ	Z	Α	В	С	D	Е
Month	Jan	F	eb	Mar	Apr	М	lay	Jun	Jul	A	ug	Sep	Oct	N	ov	Dec
Code	1		2	3	4		5	6	7		8	9	0	1	٧	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characte	ristic	Symbol	Value	Units
Drain-Source Voltage		V _{DSS}	100	V
Drain-Gate Voltage $R_{GS} \le 20 K\Omega$		V_{DGR}	100	V
Gate-Source Voltage	Continuous	V _{GSS}	±20	V
Drain Current (Note 6)	Continuous Pulsed	I _D I _{DM}	170 680	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

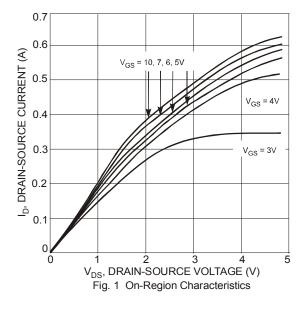
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

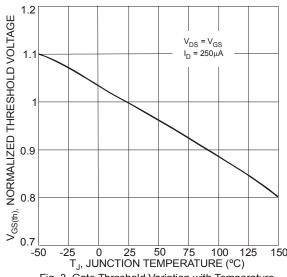
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0 10	μA nA	$V_{DS} = 100V, V_{GS} = 0V$ $V_{DS} = 20V, V_{GS} = 0V$	
Gate-Body Leakage, Forward	I _{GSSF}	_	_	50	nA	$V_{GS} = 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	8.0	1.4	2.0	>	$V_{DS} = V_{GS}$, $I_D = 1mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	6.0 10	Ω	$V_{GS} = 10V, I_D = 0.17A$ $V_{GS} = 4.5V, I_D = 0.17A$	
Forward Transconductance	g FS	80	370	_	mS	V _{DS} = 10V, I _D = 0.17A, f = 1.0KHz	
Drain-Source Diode Forward Voltage	V_{SD}	_	0.84	1.3	V	$V_{GS} = 0V$, $I_S = 0.34A$	
DYNAMIC CHARACTERISTICS (Note 8)	•		•				
Input Capacitance	C _{iss}	_	29	60	pF		
Output Capacitance	Coss	_	10	15	pF	V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	2	6	pF		
SWITCHING CHARACTERISTICS(Note 8)							
Turn-On Rise Time	t _r	_	_	8	ns		
Turn-Off Fall Time	t _f	_	_	16	ns	$V_{DD} = 30V, I_D = 0.28A,$	
Turn-On Delay Time	t _{D(ON)}	_	_	8	ns	$R_{GEN} = 50\Omega$, $V_{GS} = 10V$	
Turn-Off Delay Time	t _{D(OFF)}	_	_	13	ns		

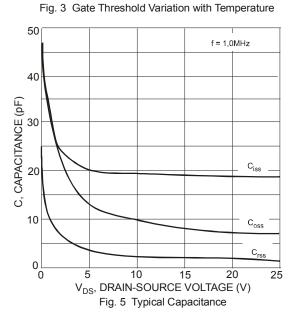
Notes:

- 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.









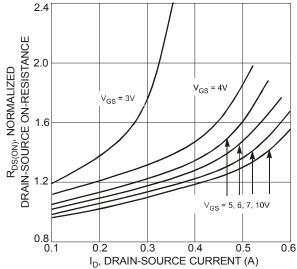


Fig. 2 On-Resistance Variation with Gate Voltage and Drain-Source Current

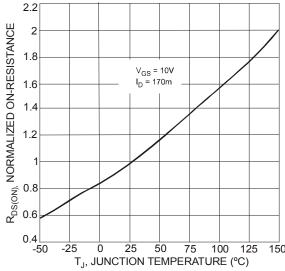


Fig. 4 On-Resistance Variation with Temperature

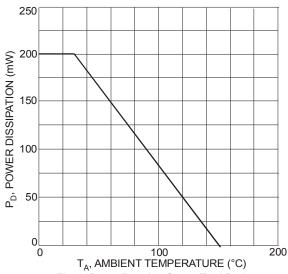
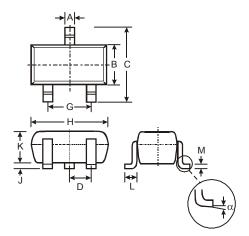


Fig. 6 Power Derating Curve, Total Package



Package Outline Dimensions

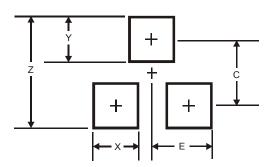
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT323							
Dim	Min	Max	Тур					
Α	0.25	0.40	0.30					
В	1.15	1.35	1.30					
C	2.00	2.20	2.10					
D	-	-	0.65					
G	1.20	1.40	1.30					
Н	1.80	2.20	2.15					
7	0.0	0.10	0.05					
K	0.90	1.00	0.95					
L	0.25	0.40	0.30					
М	0.10	0.18	0.11					
α	0°	8°	-					
All Dimensions in mm								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Υ	0.9
С	1.9
Е	1.0



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